

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -
Wholesale and Retail.

Fast Thyristor Type FDT80-2000-25

Low switching losses
Distributed amplified gate for high di_T/dt

Mean on-state current	I_{TAV}	2000 A		
Repetitive peak off-state voltage	V_{DRM}	2000...2500 V		
Repetitive peak reverse voltage	V_{RRM}			
Turn-off time	t_q	40.0, 50.0, 63.0 μs		
V_{DRM}, V_{RRM}, V	2000	2200	2400	2500
Voltage code	20	22	24	25
$T_j, ^\circ C$		-60...+125		

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Maximum allowable mean on-state current	A	2000 2249 3315	$T_c=91^\circ C$; Double side cooled; $T_c=85^\circ C$; Double side cooled; $T_c=55^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	3140	$T_c=91^\circ C$; Double side cooled; 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	45.0 52.0	$T_j=T_{j \max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
			47.0 54.0	$T_j=T_{j \max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
I^2t	Safety factor	$A^2 \cdot 10^3$	10100 13500	$T_j=T_{j \max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
			9100 12100	$T_j=T_{j \max}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=I_{FGM}$; $V_G=20$ V; $t_{GP}=50$ μs ; $di_G/dt=2$ A/ μs
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000...2500	$T_{j \min} < T_j < T_{j \max}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100...2600	$T_{j \min} < T_j < T_{j \max}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j=T_{j \max}$; Gate open	

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TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j = T_{j \max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	8	$T_j = T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	2500	$T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 8000$ A; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60...+50	
T_j	Operating junction temperature	°C	-60...+125	
MECHANICAL				
F	Mounting force	kN	40.0...50.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

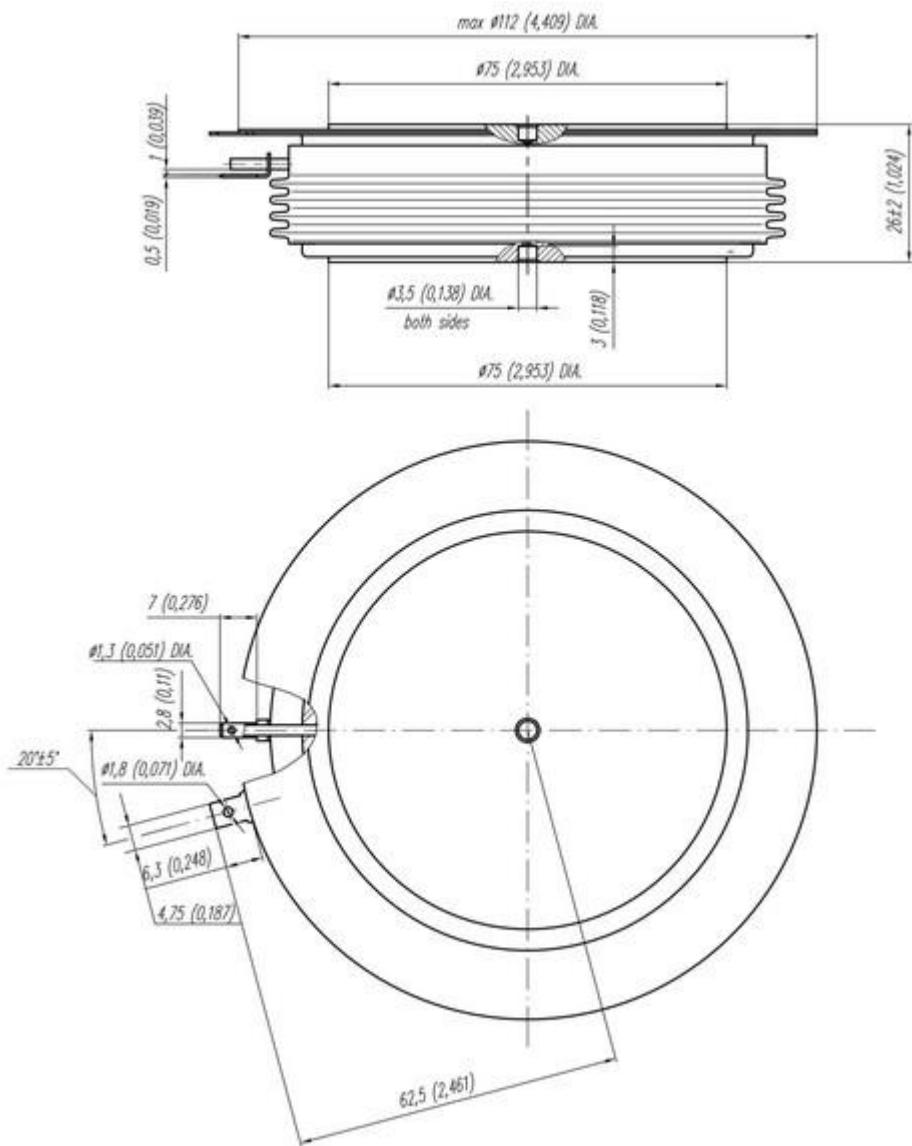
Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V_{TM}	Peak on-state voltage, max	V	2.15	$T_j = 25$ °C; $I_{TM} = 6280$ A		
$V_{T(TO)}$	On-state threshold voltage, max	V	1.265	$T_j = T_{j \max};$		
r_T	On-state slope resistance, max	$m\Omega$	0.150	0.5 π $I_{TAV} < I_T < 1.5 \pi$ I_{TAV}		
I_H	Holding current, max	mA	1000	$T_j = 25$ °C; $V_D = 12$ V; Gate open		
BLOCKING						
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j \max};$ $V_D = V_{DRM}; V_R = V_{RRM}$		
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j \max};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open		
TRIGGERING						
V_{GT}	Gate trigger direct voltage, max	V	3.00 3.00 1.50	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current	
I_{GT}	Gate trigger direct current, max	mA	500 300 150	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$		
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM};$		
I_{GD}	Gate non-trigger direct current, min	mA	70.00	Direct gate current		
SWITCHING						
t_{gd}	Delay time, max	μ s	1.10	$T_j = 25$ °C; $V_D = 1000$ V; $I_{TM} = I_{TAV};$ $di/dt = 200$ A/ μ s;		
t_{gt}	Turn-on time ²⁾ , max	μ s	2.50, 3.20, 4.00, 6.30	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ μ s		
t_q	Turn-off time ³⁾ , max	μ s	40.0, 50.0, 63.0	$dv_D/dt = 50$ V/ μ s;	$T_j = T_{j \max};$ $I_{TM} = I_{TAV};$ $di_R/dt = -10$ A/ μ s;	
			50.0, 63.0, 80.0	$dv_D/dt = 200$ V/ μ s;	$V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$	
Q_{rr}	Recovered charge, max	μ C	1230	$T_j = T_{j \max}; I_{TM} = 1000$ A;		
t_{rr}	Reverse recovery time, max	μ s	9.00	$di_R/dt = -50$ A/ μ s;		
I_{rr}	Reverse recovery current, max	A	274	$V_R = 100$ V		

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THERMAL						
R_{thjc}	Thermal resistance, junction to case, max			$^{\circ}\text{C}/\text{W}$	0.0085	Double side cooled Anode side cooled Cathode side cooled
R_{thjc-A}					0.0187	
R_{thjc-K}					0.0153	
R_{thck}	Thermal resistance, case to heatsink, max			$^{\circ}\text{C}/\text{W}$	0.0020	Direct current
MECHANICAL						
m	Weight, max			g	1170	
D_s	Surface creepage distance			mm (inch)	36.6 (1.441)	
D_a	Air strike distance			mm (inch)	16.2 (0.638)	

PART NUMBERING GUIDE							NOTES																							
FDT 80 2000 25 7 2 3							1) Critical rate of rise of off-state voltage																							
1 2 3 4 5 6 7							<table border="1"> <thead> <tr> <th>Symbol of Group</th><th>4</th><th>5</th><th>6</th><th>7</th><th>8</th><th>8,5</th><th>9</th></tr> </thead> <tbody> <tr> <td>$(dv_D/dt)_{crit}, \text{V}/\mu\text{s}$</td><td>200</td><td>320</td><td>500</td><td>1000</td><td>1600</td><td>2000</td><td>2500</td></tr> </tbody> </table>								Symbol of Group	4	5	6	7	8	8,5	9	$(dv_D/dt)_{crit}, \text{V}/\mu\text{s}$	200	320	500	1000	1600	2000	2500
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All dimensions in millimeters (inches)